SLOVENSKI STANDARD
SIST EN 62680-3-1:2018

01-marec-2018

Vmesniki univerzalnega serijskega vodila za prenos podatkov in napajanje - 3-1. del: Specifikacija univerzalnega serijskega vodila 3.1 (IEC 62680-3-1:2017)

Universal Serial Bus interfaces for data and power - Part 3-1: Universal Serial Bus 3.1 Specification (IEC 62680-3-1:2017)

Schnittstellen des Universellen Seriellen Busses für Daten und Energie - Teil 3-1: Festlegung Universeller Serieller Bus 3.1 (IEC 62680-3-1:2017)

Interfaces de bus universel en série pour les données et l'alimentation électrique - Partie 3-1: Spécification du bus universel en série 3.1 (IEC 62680-3-1:2017)

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35.200	Vmesniška in povezovalna oprema	Interface and interconnection equipment

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EUROPEAN STANDARD

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Europäisches Komitee für Elektrotechnische Normung

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European foreword

The text of document 100/2589/CDV, future edition 1 of IEC 62680-3-1, prepared by Technical Area 14 "Interfaces and methods of measurement for personal computing equipment", of IEC/TC 100 "Audio, video and multimedia systems and equipment" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 62680-3-1:2017.

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INTERNATIONAL STANDARD

colour inside

Universal Serial Bus interfaces for data and power –
Part 3-1: Universal Serial Bus 3.1 Specification

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UNIVERSAL SERIAL BUS INTERFACES FOR DATA AND POWER –

Part 3-1: Universal Serial Bus 3.1 Specification

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The text of this standard is based on the following documents:

CDV	Report on voting
100/2589/CDV	100/2684/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

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Universal Serial Bus 3.1 Specification

Hewlett-Packard Company

Intel Corporation

Microsoft Corporation

Renesas Corporation

ST-Ericsson

Texas Instruments

Revision 1.0

July 26, 2013

Revision History

Revision	Comments	Issue Date
1.0	Initial release. USB 3.0	November 12, 2008
	Incorporated errata and ECNs	June 6, 2011
1.0	Initial release. USB 3.1	July 26, 2013

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Acknowledgement of Technical Contribution

Dedication
Dedicated to the memory of Brad Hosler, the impact of whose accomplishments made the Universal Serial Bus one of the most successful technology innovations of the Personal Computer era.

The authors of this specification would like to recognize the following people who participated in the USB 3.0 Bus Specification technical workgroups. We would also like to acknowledge the many others throughout the industry who provided feedback and contributed to the development of this specification.

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